

## Terminal Voltage ±5V, 64 Taps, 2-Wire

## X9221

## Dual Digitally Controlled Potentiometer (XDCP™)

#### **FEATURES**

- Two XDCPs in one package
- 2-wire serial interface
- Register oriented format
  - —Directly write wiper position
  - -Read wiper position
  - -Store as many as four positions per pot
- Instruction format
  - Quick transfer of register contents to resistor array
- Low power CMOS
- Direct write cell
  - -Endurance-100,000 writes per bit per register
  - -Register data retention-100 years
- Bytes of EEPROM memory
- Resistor array values
  - -2K $\Omega$  to 50K $\Omega$  mask programmable
- · Resolution: 64 taps each pot
- 20-lead plastic DIP and 20-lead SOIC packages

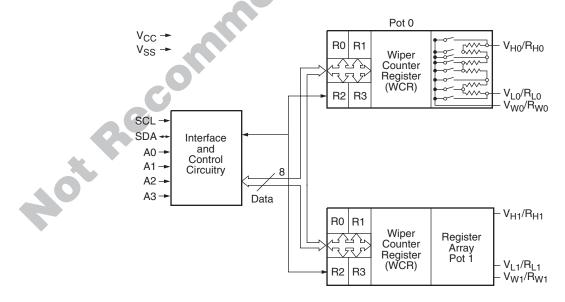
#### **DESCRIPTION**

The X9221 integrates two digitally controlled potentiometers (XDCP) on a monolithic CMOS integrated microcircuit.

The digitally controlled potentiometer is implemented using 63 resistive elements in a series array. Between each element are tap points connected to the wiper terminal through switches. The position of the wiper on the array is controlled by the user through the 2-wire bus interface. Each potentiometer has associated with it a volatile Wiper Counter Register (WCR) and 4 non-volatile Data Registers (DR0:DR3) that can be directly written to and read by the user. The contents of the WCR controls the position of the wiper on the resistor array through the switches. Power up recalls the contents of DR0 to the WCR.

The XDCP can be used as a three-terminal potentiometer or as a two-terminal variable resistor in a wide variety of applications including control, parameter adjustments, and signal processing.

#### **BLOCK DIAGRAM**



#### PIN DESCRIPTIONS

#### Host Interface Pins

#### Serial Clock (SCL)

The SCL input is used to clock data into and out of the X9221.

#### Serial Data (SDA)

SDA is a bidirectional pin used to transfer data into and out of the device. It is an open drain output and may be wire-ORed with any number of open drain or open collector outputs. An open drain output requires the use of a pull-up resistor. For selecting typical values, refer to the guidelines for calculating typical values on the bus pull-up resistors graph.

#### **Address**

The Address inputs are used to set the least significant 4 bits of the 8-bit slave address. A match in the slave address serial data stream must be made with the Address input in order to initiate communication with the X9221

### Potentiometer Pins

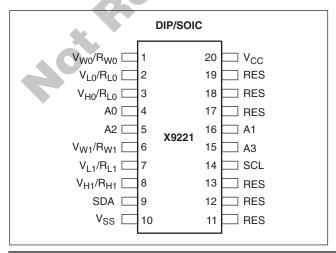
## $V_{H}/R_{H}(V_{H0}/R_{H0}-V_{H1}/R_{H1}), V_{L}/R_{L}(V_{L0}/R_{L0}-V_{L1}/R_{L1})$

The  $V_H/R_H$  and  $V_L/R_L$  inputs are equivalent to the terminal connections on either end of a mechanical potentiometer.

## $V_W/R_W (V_{W0}/R_{W0}-V_{W1}/R_{W1})$

The wiper outputs are equivalent to the wiper output of a mechanical potentiometer.

#### PIN CONFIGURATION



#### **PIN NAMES**

Symbol	Description
SCL	Serial Clock
SDA	Serial Data
A0-A3	Address
V <sub>H0</sub> /R <sub>H0</sub> -V <sub>H1</sub> /R <sub>H1</sub> , V <sub>L0</sub> /R <sub>H0</sub> -V <sub>L1</sub> /R <sub>L0</sub>	Potentiometers (terminal equivalent)
V <sub>W0</sub> /R <sub>W0</sub> -V <sub>W1</sub> /R <sub>W1</sub>	Potentiometers (wiper equivalent)
RES	Reserved (Do not connect)

#### PRINCIPLES OF OPERATION

The X9221 is a highly integrated microcircuit incorporating two resistor arrays, their associated registers and counters and the serial interface logic providing direct communication between the host and the XDCP potentiometers.

#### Serial Interface

The X9221 supports a bidirectional bus oriented protocol. The protocol defines any device that sends data onto the bus as a transmitter and the receiving device as the receiver. The device controlling the transfer is a master and the device being controlled is the slave. The master will always initiate data transfers and provide the clock for both transmit and receive operations. Therefore, the X9221 will be considered a slave device in all applications.

#### **Clock and Data Conventions**

Data states on the SDA line can change only during SCL LOW periods ( $t_{LOW}$ ). SDA state changes during SCL HIGH are reserved for indicating start and stop conditions.

#### **Start Condition**

All commands to the X9221 are preceded by the start condition, which is a HIGH to LOW transition of SDA while SCL is HIGH (t<sub>HIGH</sub>). The X9221 continuously monitors the SDA and SCL lines for the start condition, and will not respond to any command until this condition is met.

## **Stop Condition**

All communications must be terminated by a stop condition, which is a LOW to HIGH transition of SDA while SCL is HIGH.

### **Acknowledge**

Acknowledge is a software convention used to provide a positive handshake between the master and slave devices on the bus to indicate the successful receipt of data. The transmitting device, either the master or the slave, will release the SDA bus after transmitting eight bits. The master generates a ninth clock cycle and during this period the receiver pulls the SDA line LOW to acknowledge that it successfully received the eight bits of data. See Figure 7.

The X9221 will respond with an acknowledge after recognition of a start condition and its slave address and once again after successful receipt of the command byte. If the command is followed by a data byte the X9221 will respond with a final acknowledge.

#### **Array Description**

The X9221 is comprised of two resistor arrays. Each array contains 63 discrete resistive segments that are connected in series. The physical ends of each array are equivalent to the fixed terminals of a mechanical potentiometer ( $V_H/R_H$  and  $V_I/R_I$  inputs).

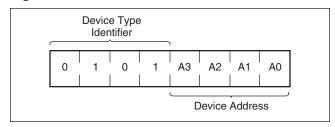
At both ends of each array and between each resistor segment is a FET switch connected to the wiper ( $V_W/R_W$ ) output. Within each individual array only one switch may be turned on at a time. These switches are controlled by the Wiper Counter Register (WCR). The six least significant bits of the WCR are decoded to select, and enable, one of sixty-four switches.

The WCR may be written directly, or it can be changed by transferring the contents of one of four associated data registers into the WCR. These data registers and the WCR can be read and written by the host system.

#### **Device Addressing**

Following a start condition the master must output the address of the slave it is accessing. The most significant four bits of the slave address are the device type identifier (refer to Figure 1 below). For the X9221 this is fixed as 0101[B].

Figure 1. Slave Address

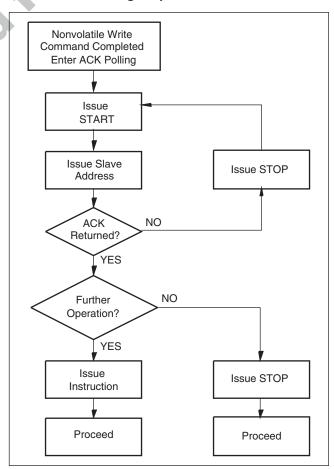


The next four bits of the slave address are the device address. The physical device address is defined by the state of the A0-A3 inputs. The X9221 compares the serial data stream with the address input state; a successful compare of all four address bits is required for the X9221 to respond with an acknowledge.

#### **Acknowledge Polling**

The disabling of the inputs, during the internal nonvolatile write operation, can be used to take advantage of the typical 5ms EEPROM write cycle time. Once the stop condition is issued to indicate the end of the nonvolatile write command the X9221 initiates the internal write cycle. ACK polling can be initiated immediately. This involves issuing the start condition followed by the device slave address. If the X9221 is still busy with the write operation no ACK will be returned. If the X9221 has completed the write operation an ACK will be returned and the master can then proceed with the next operation.

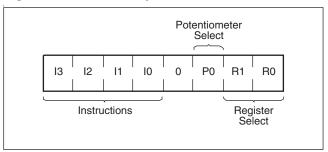
Flow 1. ACK Polling Sequence



#### **Instruction Structure**

The next byte sent to the X9221 contains the instruction and register pointer information. The four most significant bits are the instruction. The next four bits point to one of two pots and when applicable they point to one of four associated registers. The format is shown below in Figure 2.

Figure 2. Instruction Byte Format



The four high order bits define the instruction. The sixth bit (P0) selects which one of the two potentiometers is to be affected by the instruction. The last two bits (R1 and R0) select one of the four registers that is to be acted upon when a register oriented instruction is issued.

Four of the nine instructions end with the transmission of the instruction byte. The basic sequence is illustrated in Figure 3. These two-byte instructions exchange data between the WCR and one of the data registers. A transfer from a data register to a WCR is essentially a write to a static RAM. The response of

the wiper to this action will be delayed t<sub>STPWV</sub>. A transfer from WCR's current wiper position to a data register is a write to nonvolatile memory and takes a minimum of t<sub>WR</sub> to complete. The transfer can occur between either potentiometer and their associated registers or it may occur between both of the potentiometers and one of their associated registers.

Four instructions require a three-byte sequence to complete. These instructions transfer data between the host and the X9221; either between the host and one of the data registers or directly between the host and the WCR. These instructions are: Read WCR, read the current wiper position of the selected pot; Write WCR, change current wiper position of the selected pot; Read Data Register, read the contents of the selected nonvolatile register; Write Data Register, write a new value to the selected data register. The sequence of operations is shown in Figure 4.

The Increment/Decrement command is different from the other commands. Once the command is issued and the X9221 has responded with an acknowledge, the master can clock the selected wiper up and/or down in one segment steps; thereby, providing a fine tuning capability to the host. For each SCL clock pulse (t<sub>HIGH</sub>) while SDA is HIGH, the selected wiper will move one resistor segment towards the  $V_{\rm H}/R_{\rm H}$  terminal. Similarly, for each SCL clock pulse while SDA is LOW, the selected wiper will move one resistor segment towards the  $V_{\rm L}/R_{\rm L}$  terminal. A detailed illustration of the sequence and timing for this operation are shown in Figures 5 and 6 respectively.

Figure 3. Two-Byte Command Sequence

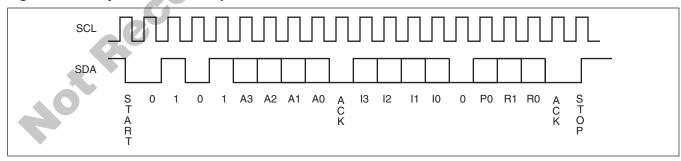


Figure 4. Three-Byte Command Sequence

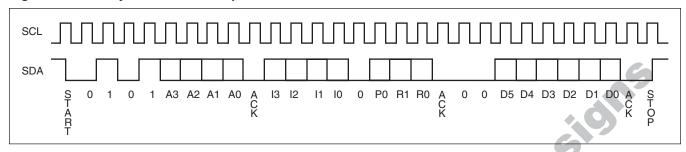
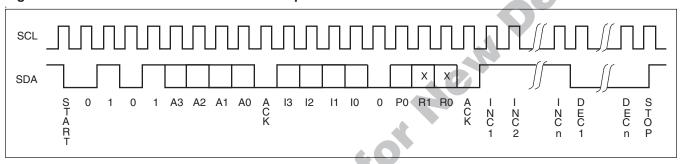
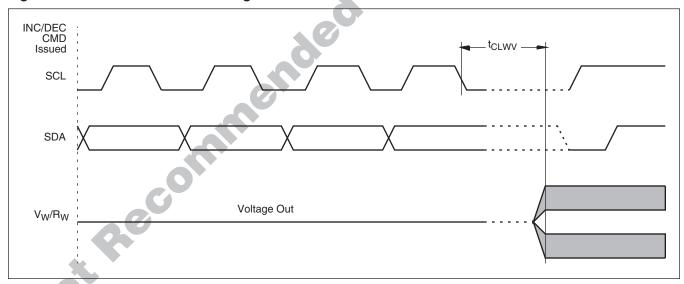


Figure 5. Increment/Decrement Command Sequined



**Figure 6. Increment/Decrement Timing Limits** 

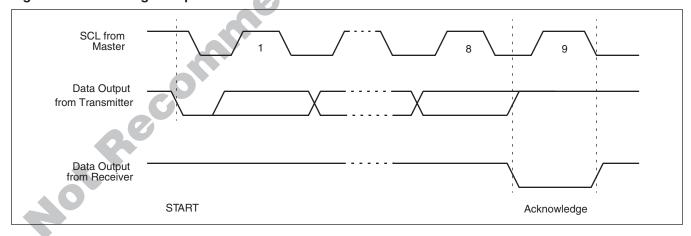


**Table 1. Instruction Set** 

	Instruction Format								
Instruction	l <sub>3</sub>	l <sub>2</sub>	I <sub>1</sub>	I <sub>0</sub>	0	P <sub>0</sub>	R <sub>1</sub>	R <sub>0</sub>	Operation
Read WCR	1	0	0	1	0	1/0	N/A <sup>(7)</sup>	N/A	Read the contents of the Wiper Counter Register pointed to by $P_0$
Write WCR	1	0	1	0	0	1/0	N/A	N/A	Write new value to the Wiper Counter Register pointed to by P <sub>0</sub>
Read Data Register	1	0	1	1	0	1/0	1/0	1/0	Read the contents of the Register pointed to by $P_0$ and $R_1$ – $R_0$
Write Data Register	1	1	0	0	0	1/0	1/0	1/0	Write new value to the Register pointed to by $P_0$ and $R_1$ – $R_0$
XFR Data Register to WCR	1	1	0	1	0	1/0	1/0	1/0	Transfer the contents of the Register pointed to by $P_0$ and $R_1$ – $R_0$ to its associated WCR
XFR WCR to Data Register	1	1	1	0	0	1/0	1/0	1/0	Transfer the contents of the WCR pointed to by $P_0$ to the Register pointed to by $R_1$ – $R_0$
Global XFR Data Register to WCR	0	0	0	1	N/A	N/A	1/0	1/0	Transfer the contents of the Data Registers pointed to by R <sub>1</sub> –R <sub>0</sub> of both pots to their respective WCR
Global XFR WCR to Data Register	1	0	0	0	N/A	N/A	1/0	1/0	Transfer the contents of all WCRs to their respective data Registers pointed to by R <sub>1</sub> –R <sub>0</sub> of both pots
Increment/ Decrement Wiper	0	0	1	0	0	1/0	N/A	N/A	Enable Increment/decrement of the WCR pointed to by P <sub>0</sub>

Note: (7) N/A = Not applicable or don't care; that is, a data register is not involved in the operation and need not be addressed (typical)

Figure 7. Acknowledge Response from Receiver



#### **DETAILED OPERATION**

Both XDCP potentiometers share the serial interface and share a common architecture. Each potentiometer is comprised of a resistor array, a wiper counter register and four data registers. A detailed discussion of the register organization and array operation follows.

#### **Wiper Counter Register**

The X9221 contains two wiper counter registers (WCR), one for each XDCP potentiometer. The WCR can be envisioned as a 6-bit parallel and serial load counter with its outputs decoded to select one of sixty-four switches along its resistor array. The contents of the WCR can be altered in four ways: it may be written directly by the host via the Write WCR instruction (serial load); it may be written indirectly by transferring the contents of one of four associated data registers via the XFR Data Register instruction (parallel load); it can be modified one step at a time by the Increment/ Decrement instruction; finally, it is loaded with the contents of its data register zero (R0) upon power-up.

The WCR is a volatile register; that is, its contents are lost when the X9221 is powered-down. Although the register is automatically loaded with the value in R0 upon power-up, it should be noted this may be different from the value present at power-down.

#### **Data Registers**

Each potentiometer has four nonvolatile data registers. These can be read or written directly by the host and data can be transferred between any of the four data registers and the WCR. It should be noted all operations changing data in one of these registers is a nonvolatile operation and will take a maximum of 10ms.

If the application does not require storage of multiple settings for the potentiometer, these registers can be used as regular memory locations that could possibly store system parameters or user preference data.

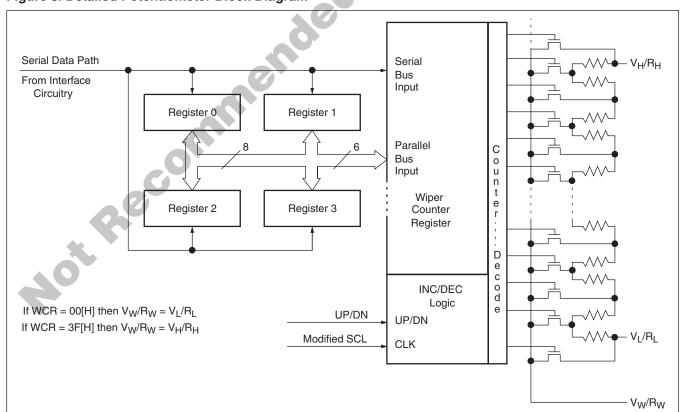


Figure 8. Detailed Potentiometer Block Diagram

#### **ABSOLUTE MAXIMUM RATINGS**

Temperature under bias65°C to	+135°C
Storage temperature65°C to	+150°C
Voltage on SCK, SCL or any address	
input with respect to V <sub>SS</sub> 1V	′ to +7V
Voltage on any V <sub>H</sub> /R <sub>H</sub> or V <sub>L</sub> /R <sub>L</sub>	
referenced to V <sub>SS</sub>	±8V
$\Delta V =  V_H/R_H - V_L/R_L $	16V
Lead temperature (soldering, 10 seconds)	300°C
I <sub>W</sub> (10 seconds)	±12mA

#### **COMMENT**

Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only; functional operation of the device (at these or any other conditions above those indicated in the operational sections of this specification) is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### RECOMMENDED OPERATING CONDITIONS

Temperature	Min.	Max.		
Commercial	0°C	+70°C		
Industrial	–40°C	+85°C		

Supply Voltage	Limits
X9221	5V ±10%

## ANALOG CHARACTERISTICS (Over recommended operating conditions unless otherwise stated.)

		Limits				
Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions
R <sub>TOTAL</sub>	End to End Resistance	-20		+20	%	
	Power Rating	X		50	mW	25°C, each pot
I <sub>W</sub>	Wiper Current	-6		+6	mA	
R <sub>W</sub>	Wiper Resistance		40	100	Ω	Wiper Current = ± 1mA
V <sub>TERM</sub>	Voltage on any V <sub>H</sub> /R <sub>H</sub> or V <sub>L</sub> /R <sub>L</sub> Pin	-5		+5	V	
	Noise		≤120		dB/√Hz	Ref: 1V
	Resolution			1.6	%	
	Absolute Linearity <sup>(1)</sup>	-1		+1	MI <sup>(3)</sup>	V <sub>w(n)(actual)</sub> -V <sub>w(n)(expected)</sub>
	Relative Linearity <sup>(2)</sup>	-0.2		+0.2	MI <sup>(3)</sup>	$V_{w(n + 1)} - [V_{w(n) + MI}]$
	Temperature Coefficient		±300		ppm/°C	
	Radiometric Temperature Coefficient					
C <sub>H</sub> /C <sub>L</sub> /C <sub>W</sub>	Potentiometer Capacitances		10/10/25		pF	See circuit #3

## D.C. OPERATING CHARACTERISTICS (Over recommended operating conditions unless otherwise stated.)

		Limits				
Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions
Icc	Supply Current (Active)			3	mA	$f_{SCL} = 100kHz$ , SDA = Open, Other Inputs = $V_{SS}$
I <sub>SB</sub>	V <sub>CC</sub> Current (Standby)		200	500	μΑ	SCL = SDA = V <sub>CC</sub> , Addr. = V <sub>SS</sub>
I <sub>LI</sub>	Input Leakage Current			10	μΑ	$V_{IN} = V_{SS}$ to $V_{CC}$
I <sub>LO</sub>	Output Leakage Current			10	μΑ	V <sub>OUT</sub> = V <sub>SS</sub> to V <sub>CC</sub>
V <sub>IH</sub>	Input HIGH Voltage	2		V <sub>CC</sub> + 1	V	
V <sub>IL</sub>	Input LOW Voltage	-1		0.8	V	
V <sub>OL</sub>	Output LOW Voltage			0.4	V	I <sub>OL</sub> = 3mA

**Notes:** (1) Absolute Linearity is utilized to determine actual wiper voltage versus expected voltage as determined by wiper position when used as a potentiometer.

- (2) Relative Linearity is utilized to determine the actual change in voltage between two successive tap positions when used as a potentiometer. It is a measure of the error in step size.
- (3) MI = RTOT/63 or  $(V_H/R_H-V_L/R_L)/63$ , single pot

#### **ENDURANCE AND DATA RETENTION**

Parameter	Min.	Unit			
Minimum endurance	100,000	Data changes per bit per register			
Data retention	100	years			

#### **CAPACITANCE**

Symbol	Parameter	Max.	Unit	Test Conditions
C <sub>I/O</sub> <sup>(5)</sup>	Input/output capacitance (SDA)	8	pF	V <sub>I/O</sub> = 0V
C <sub>IN</sub> <sup>(5)</sup>	Input capacitance (A0, A1, A2, A3 and SCL)	6	pF	V <sub>IN</sub> = 0V

#### **POWER-UP TIMING**

Symbol	Parameter	Max.	Unit
t <sub>PUR</sub> <sup>(6)</sup>	Power-up to initiation of read operation	1	ms
t <sub>PUW</sub> <sup>(6)</sup>	Power-up to initiation of write operation	5	ms
t <sub>R</sub> V <sub>CC</sub>	V <sub>CC</sub> Power-up range rate	50	V/nsec

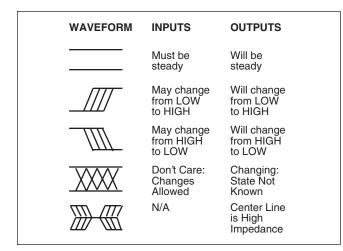
## A.C. CONDITIONS OF TEST

Input pulse levels	V <sub>CC</sub> x 0.1 to V <sub>CC</sub> x 0.9
Input rise and fall times	10ns
Input and output timing levels	V <sub>CC</sub> x 0.5

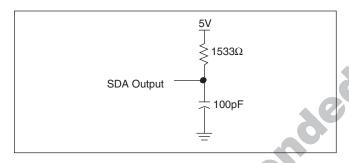
Notes: (5) This parameter is periodically sampled and not 100% tested

(6) t<sub>PUR</sub> and t<sub>PUW</sub> are the delays required from the time V<sub>CC</sub> is stable until the specified operation can be initiated. These parameters are periodically sampled and not 100% tested.

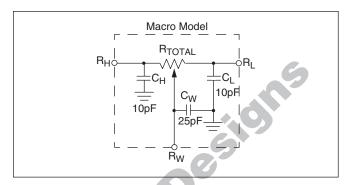
#### **SYMBOL TABLE**



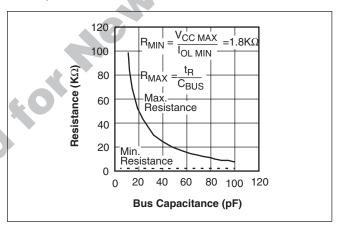
## **Equivalent A.C. Test Circuit**



#### Circuit #3 SPICE Macro Model



# Guidelines for Calculating Typical Values of Bus Pull-Up Resistors



## A.C. CHARACTERISTICS (Over recommended operating conditions unless otherwise stated)

			nits		Reference
Symbol	Parameter	Min.	Max.	Unit	Figure
f <sub>SCL</sub>	SCL clock frequency	0	100	kHz	10
t <sub>LOW</sub>	Clock LOW period	4700		ns	10
t <sub>HIGH</sub>	Clock HIGH period	4000		ns	10
t <sub>R</sub>	SCL and SDA rise time		1000	ns	10
tE	SCL and SDA fall time		300	ns	10
T <sub>i</sub>	Noise suppression time constant (glitch filter)		100	ns	10
tsu:sta	Start condition setup time (for a repeated start condition)	4700		ns	10 & 12
t <sub>HD:STA</sub>	Start condition hold time	4000		ns	10 & 12
t <sub>SU:DAT</sub>	Data in setup time	250		ns	10
t <sub>HD:DAT</sub>	Data in hold time	0		ns	10
t <sub>AA</sub>	SCL LOW to SDA data out valid	300	3500	ns	11
t <sub>DH</sub>	Data out hold time	300		ns	11
t <sub>SU:STO</sub>	Stop condition setup time	4700		ns	10 & 12

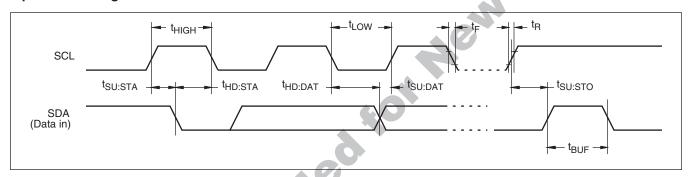
Characteristics subject to change without notice.

## A.C. CHARACTERISTICS (Continued)(Over recommended operating conditions unless otherwise stated)

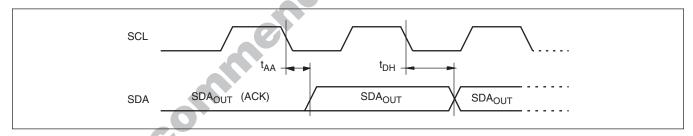
		Limits			Reference
Symbol	Parameter	Min.	Max.	Unit	Figure
t <sub>BUF</sub>	Bus free time prior to new transmission	4700		ns	10
t <sub>WR</sub>	Write cycle time (nonvolatile write operation)		10	ms	13
t <sub>STPWV</sub>	Wiper response time from stop generation		1000	μs	13
t <sub>CLWV</sub>	Wiper response from SCL LOW		500	μs	6
t <sub>R</sub> V <sub>CC</sub>	VCC power-up rate	0.2	50	mV/µs	

## **TIMING DIAGRAMS**

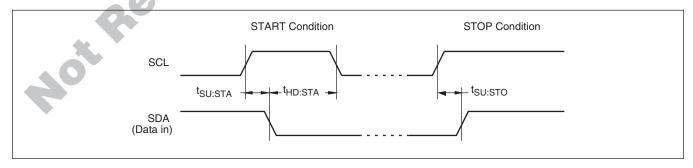
## **Input Bus Timing**



## **Output Bus Timing**

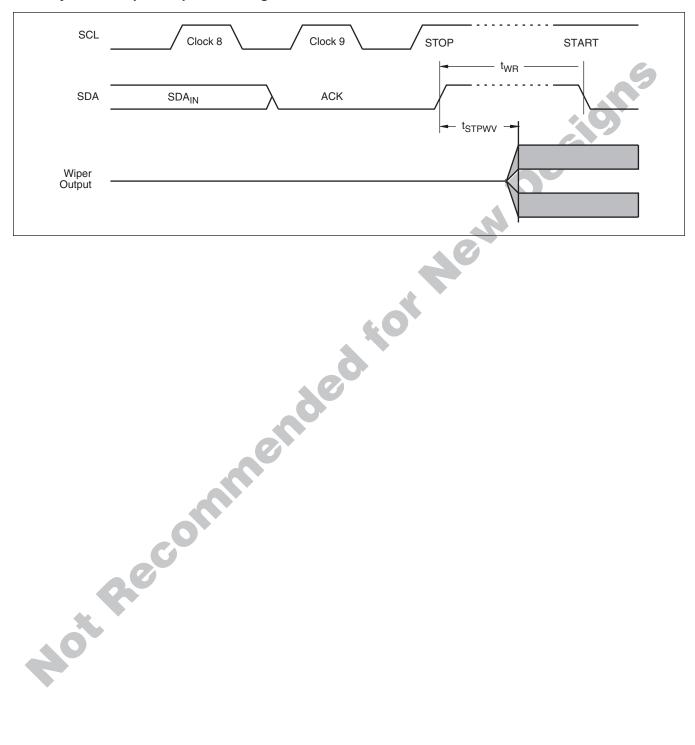


## **Start Stop Timing**



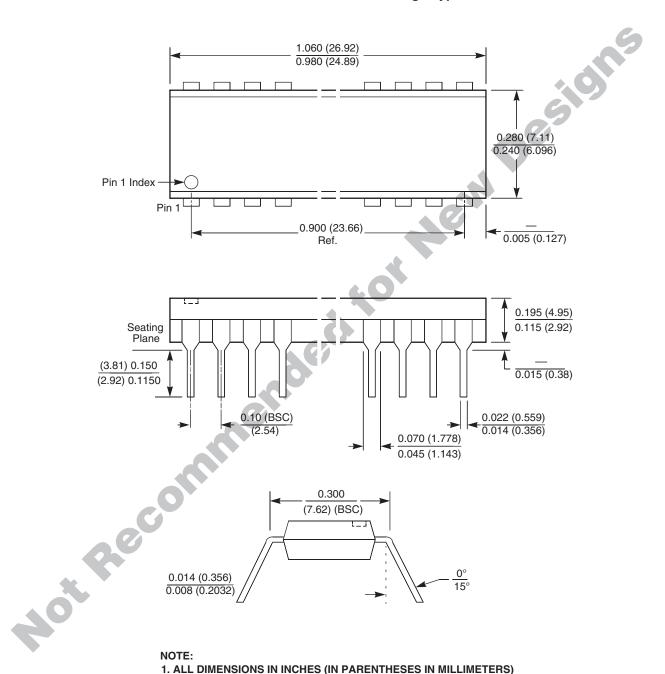
Characteristics subject to change without notice.

## Write Cycle and Wiper Response Timing



#### **PACKAGING INFORMATION**

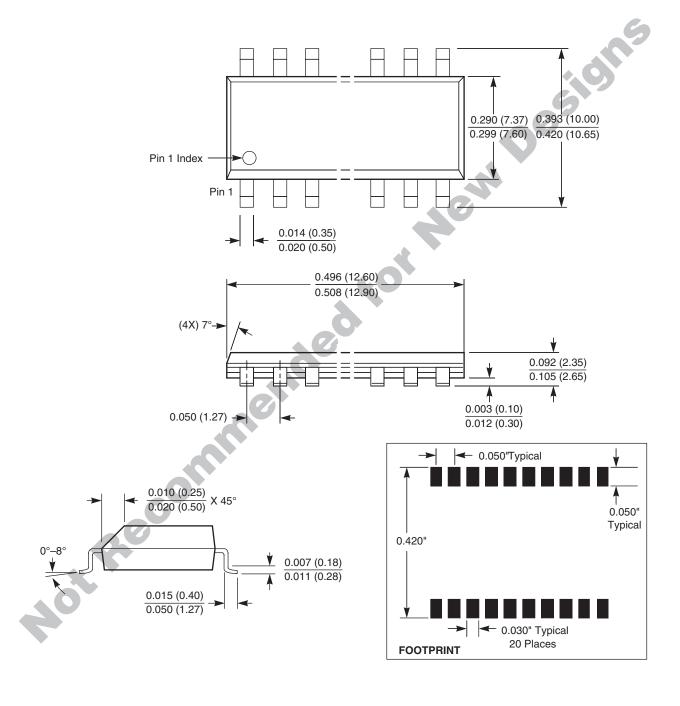
## 20-Lead Plastic Dual In-Line Package Type P



- 1. ALL DIMENSIONS IN INCHES (IN PARENTHESES IN MILLIMETERS)
  2. PACKAGE DIMENSIONS EXCLUDE MOLDING FLASH

#### **PACKAGING INFORMATION**

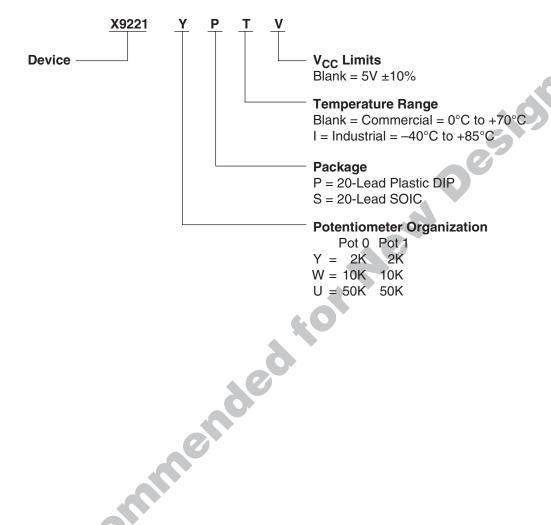
## 20-Lead Plastic Small Outline Gull Wing Package Type S



NOTE: ALL DIMENSIONS IN INCHES (IN PARENTHESES IN MILLIMETERS)

REV 1.1 8/8/02

### **Ordering Information**



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#### U.S. PATENTS

Xicor products are covered by one or more of the following U.S. Patents: 4,326,134; 4,393,481; 4,404,475; 4,450,402; 4,486,769; 4,488,060; 4,520,461; 4,533,846; 4,599,706; 4,617,652; 4,668,932; 4,752,912; 4,829,482; 4,874,967; 4,883,976; 4,980,859; 5,012,132; 5,003,197; 5,023,694; 5,084,667; 5,153,880; 5,153,691; 5,161,137; 5,219,774; 5,270,927; 5,324,676; 5,434,396; 5,544,103; 5,587,573; 5,835,409; 5,977,585. Foreign patents and additional patents pending.

#### LIFE RELATED POLICY

In situations where semiconductor component failure may endanger life, system designers using this product should design the system with appropriate error detection and correction, redundancy and back-up features to prevent such an occurrence.

Xicor's products are not authorized for use in critical components in life support devices or systems.

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
- 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.